

10A, 100V Trench Schottky Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

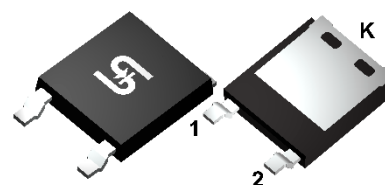
APPLICATIONS

- Low voltage, high frequency
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

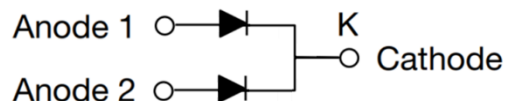
MECHANICAL DATA

- Case: ThinDPAK
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.19g (approximately)

| KEY PARAMETERS | | |
|----------------|----------------|------|
| PARAMETER | VALUE | UNIT |
| I_F | 10 | A |
| V_{RRM} | 100 | V |
| I_{FSM} | 135 | A |
| $T_{J\ MAX}$ | 175 | °C |
| Package | ThinDPAK | |
| Configuration | Common cathode | |



ThinDPAK



| ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | |
|--|--------------|--------------|------|
| PARAMETER | SYMBOL | VALUE | UNIT |
| Repetitive peak reverse voltage | V_{RRM} | 100 | V |
| Reverse voltage, total rms value | $V_{R(RMS)}$ | 70 | V |
| Forward current, per leg / per device | I_F | 5 / 10 | A |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I_{FSM} | 135 | A |
| Junction temperature | T_J | - 55 to +175 | °C |
| Storage temperature | T_{STG} | - 55 to +175 | °C |

| THERMAL PERFORMANCE | | | |
|---|------------------|------------|-------------|
| PARAMETER | SYMBOL | TYP | UNIT |
| Junction-to-lead thermal resistance per leg ⁽¹⁾ | R _{θJL} | 1.8 | °C/W |
| Junction-to-ambient thermal resistance per leg ⁽²⁾ | R _{θJA} | 7.4 | °C/W |
| Junction-to-case thermal resistance per leg ⁽²⁾ | R _{θJC} | 2.9 | °C/W |

Thermal Performance Note:

1. With ideal heat sink
2. Mounted on Heat sink with 4" x 6" x 0.25" Al-Plate

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | |
|---|---|----------------|------------|------------|-------------|
| PARAMETER | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
| Forward voltage per leg ⁽¹⁾ | I _F = 2.5A, T _J = 25°C | V _F | 0.60 | - | V |
| | I _F = 5.0A, T _J = 25°C | | 0.69 | 0.76 | V |
| | I _F = 2.5A, T _J = 125°C | | 0.51 | - | V |
| | I _F = 5.0A, T _J = 125°C | | 0.58 | 0.65 | V |
| Reverse current @ rated V _R per leg ⁽²⁾ | T _J = 25°C | I _R | - | 10 | μA |
| | T _J = 125°C | | - | 2 | mA |
| Junction capacitance per leg | 1MHz, V _R = 4.0V | C _J | 338 | - | pF |

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

| ORDERING INFORMATION | | |
|-----------------------------|----------------|---------------------|
| ORDERING CODE | PACKAGE | PACKING |
| TSAD10H100CH | ThinDPAK | 4,500 / Tape & Reel |

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

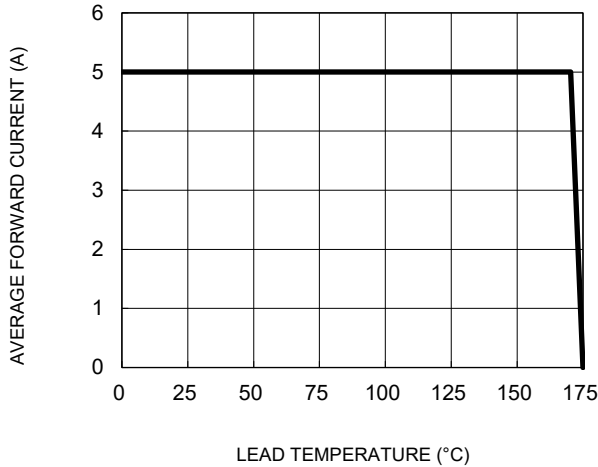


Fig.2 Typical Junction Capacitance

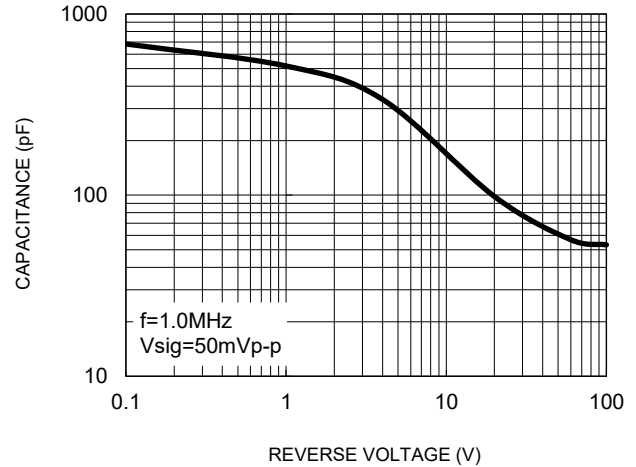


Fig.3 Typical Reverse Characteristics

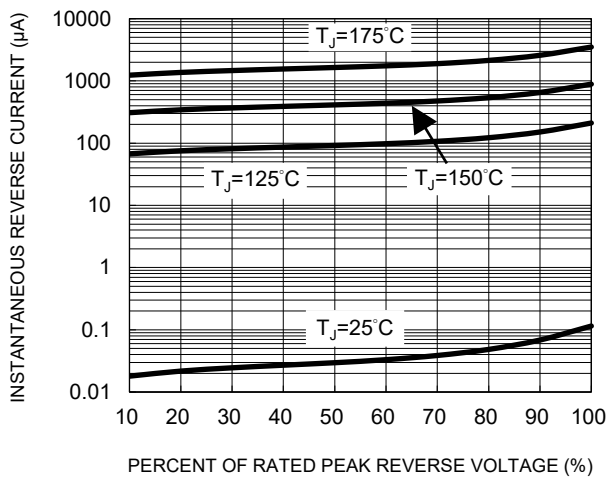


Fig.4 Typical Forward Characteristics

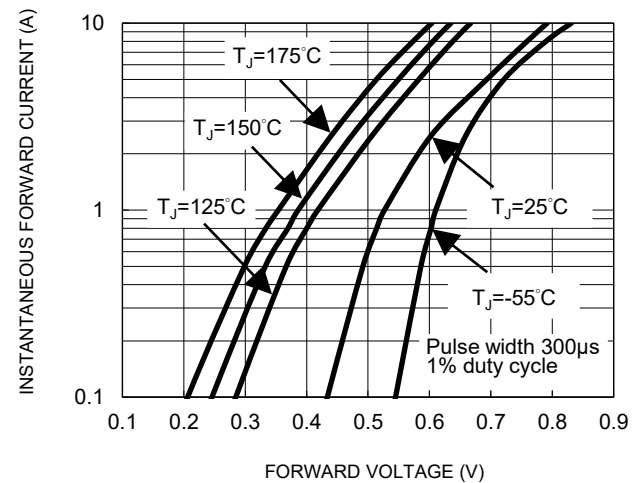
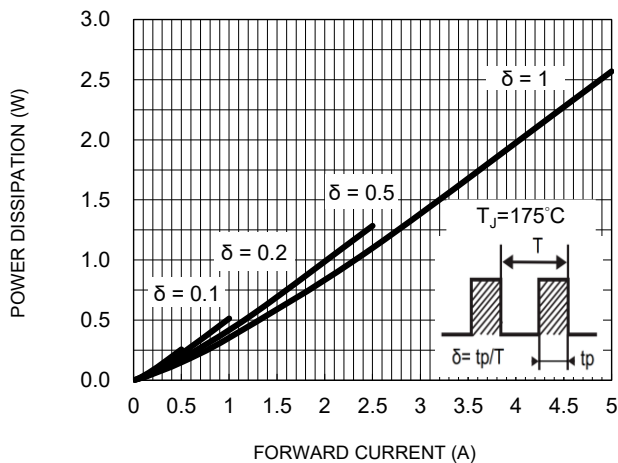


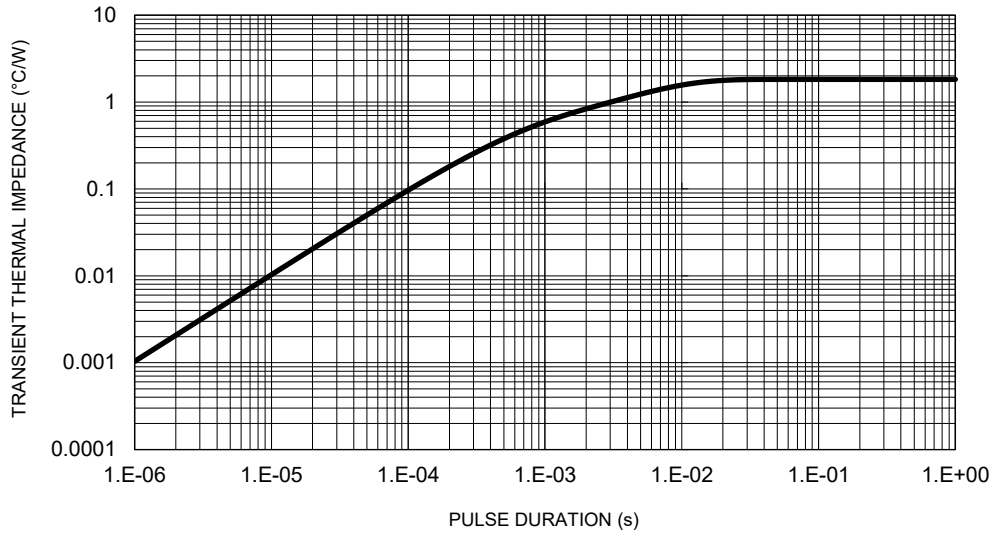
Fig.5 Typical Forward Power Dissipation vs. Forward Current



CHARACTERISTICS CURVES

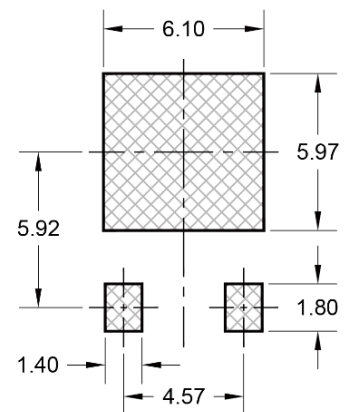
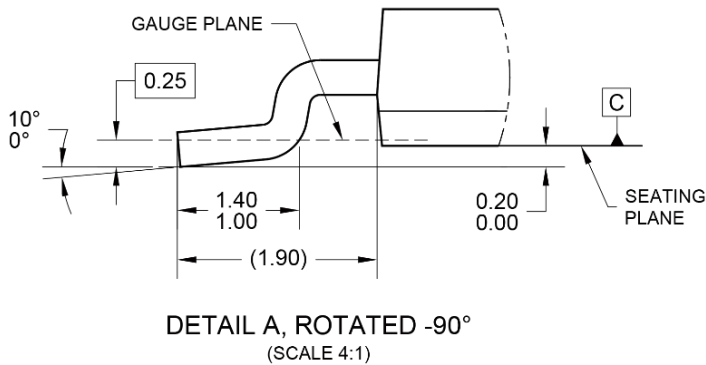
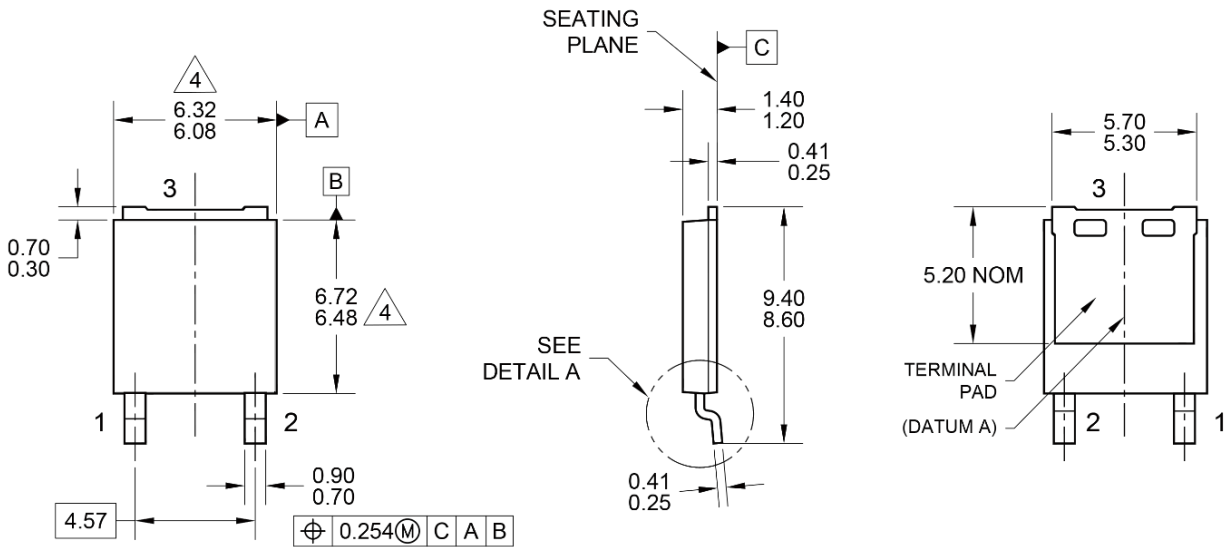
(T_A = 25°C unless otherwise noted)

Fig.6 Typical Transient Thermal Characteristics

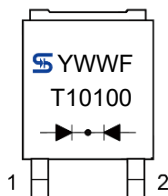


PACKAGE OUTLINE DIMENSIONS

ThinDPAK



SUGGESTED PAD LAYOUT



MARKING DIAGRAM

YWW = DATE CODE
F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC TO-252, VARIATION AE, ISSUE F.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURRS.
5. DWG NO. REF: HQ2SD07-TDPAK-065 REV A.

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